

	Document ID	Issue Date	Pages	Title	Current OR	Current XRef	Retri...
2	US 6621660 B2	20030916	10	Thin film magnetic head	360/126	360/123	
3	WO 2054458 A2	20020711	27	METHOD FOR THE MANUFACTURE OF MICRO STRUCTURES			
4	US 6540928 B1	20030401	10	Magnetic pole fabrication process and device	216/22	205/119; 216/39;	
5	US 6524491 B1	20030225	13	Double plate-up process for fabrication of composite	216/22	216/38; 216/57;	
6	US 5802700 A	19980908	25	Method of making a planarized thin film	29/603.14	29/603.15; 29/603.18;	
7	US 6547975 B1	20030415	17	Magnetic pole fabrication process and device	216/22	204/192.1; 427/251	
8	US 6521335 B1	20030218	7	Method of fabricating a submicron narrow writer pole	428/336	360/126; 428/692;	
9	US 5085750 A	19990323	8	Tantalum adhesion layer and reactive-ion-etch process	430/314	257/E21.535; 257/E21.589;	
10	JP 2003017474 A	20030117	12	THIN-FILM PATTERNING METHOD, AND MANUFACTURING METHODS OF			
11	US 6100014 A	20000808	8	Method of forming an opening in a dielectric layer	430/314	430/317; 430/324;	
12	US 5665251 A	19970909	15	RIE image transfer process for plating	216/22	216/40; 216/47;	
13	US 4803181 A	19890207	7	Process for forming sub-micrometer patterns	438/696	148/DIG.111; 148/DIG.137;	
14	US 4502914 A	19850305	23	Method of making structures with dimensions in the	438/424	204/192.3; 204/192.32;	
15	US 6423475 B1	20020723	9	Sidewall formation for sidewall patterning of sub	430/314	257/E21.314; 430/313;	
16	US 5928967 A	19990727	6	Selective oxide-to-nitride etch process using C.sub.4	438/740	257/E21.252; 257/E21.579;	
17	US 4871630 A	19891003	5	Mask using lithographic	430/14	216/46;	

 Details  Text  Image  HTML

L Number	Hits	Search Text	DB	Time stamp
1	10	"4871630"	USPAT; EPO; JPO	2003/11/04 10:45
2	5	("4234362" "4256514" "4259369" "4600686" "4778739").PN.	USPAT	2003/11/04 10:46
-	9	howard with zolla.in.	USPAT; US-PGPUB	2003/10/30 17:51
-	135	thin adj film with magnetic and photolithographically	USPAT; EPO; JPO	2003/10/30 18:47
-	16	(thin adj film with magnetic and photolithographically) and trench	USPAT; EPO; JPO	2003/10/30 17:52
-	16	thin adj film with magnetic and photolithographically	US-PGPUB	2003/10/30 18:03
-	21	29/\$.ccls. and (thin adj film with magnetic and trench and etch\$3)	USPAT; EPO; JPO	2003/10/30 18:48
-	213	thin adj film with magnetic and trench and etch\$3	USPAT; EPO; JPO	2003/10/30 18:51
-	2	438/696,947.ccls. and trench and etch\$3 and seed adj layer	USPAT; EPO; JPO	2003/10/31 11:59
-	672	438/\$.ccls. and trench and etch\$3 and seed adj layer	USPAT; EPO; JPO	2003/10/31 12:37
-	426	(438/\$.ccls. and trench and etch\$3 and seed adj layer) and plat\$3 and (strip\$4 remov\$3)	USPAT; EPO; JPO	2003/10/31 12:00
-	77	((438/\$.ccls. and trench and etch\$3 and seed adj layer) and plat\$3 and (strip\$4 remov\$3)) and side adj wall	USPAT; EPO; JPO	2003/10/31 12:00
-	4	29/\$.ccls. and trench and etch\$3 and seed adj layer and side adj wall and plat\$3 and (remov\$3 strip\$4)	USPAT; EPO; JPO	2003/10/31 12:41
-	11	216/\$.ccls. and trench and etch\$3 and seed adj layer and side adj wall and plat\$3 and (remov\$3 strip\$4)	USPAT; EPO; JPO	2003/10/31 12:42
-	21	205/\$.ccls. and trench and etch\$3 and seed adj layer and side adj wall and plat\$3 and (remov\$3 strip\$4)	USPAT; EPO; JPO	2003/10/31 12:44
-	2	360/\$.ccls. and trench and etch\$3 and seed adj layer and side adj wall and plat\$3 and (remov\$3 strip\$4)	USPAT; EPO; JPO	2003/10/31 12:45
-	36	360/126,317.ccls. and thin adj film and etch\$3 and plat\$3 and trench	USPAT; EPO; JPO	2003/10/31 12:46
-	29	("4209349" "4358340" "4377437" "4377734" "4389482" "4419809" "4445267" "4502914" "4504574" "4552833" "4601778" "4613398" "4657845" "4690729" "4751170" "4803181" "4886565" "5599745" "5665251" "5774308" "5788447" "5792593" "5825609" "5851733" "5858621" "5863705" "5895273" "6100014" "6110637").PN.	USPAT	2003/11/03 15:14
-	1	2054458.URPN.	USPAT	2003/11/03 15:19
-	29	("4209349" "4358340" "4377437" "4377734" "4389482" "4419809" "4445267" "4502914" "4504574" "4552833" "4601778" "4613398" "4657845" "4690729" "4751170" "4803181" "4886565" "5599745" "5607542" "5665251" "5788447" "5792593" "5825609" "5851733" "5858621" "5863705" "5895273" "6100014" "6110637").PN.	USPAT	2003/11/03 15:22
-	13	("5267112" "5435053" "5606478" "5639509" "5722157" "5750275" "6018862" "6097578" "6130809" "6131271" "6188544" "6191918" "6278590").PN.	USPAT	2003/11/03 15:23
-	5	("4803181" "4871630" "5895740" "5922516" "5958800").PN.	USPAT	2003/11/03 15:24

-	84	4502914.URPN.	USPAT	2003/11/03 15:25
-	75	thin adj film and head and trench and plat\$3 and seed adj layer	USPAT;	2003/11/03
-	31	pole with tip and trench and plat\$3 and seed and etch\$3	EPO; JPO	16:03
-	5	5885750.URPN.	USPAT	2003/11/03 16:04
-	6	("4315985" "4919768" "4927505" "5126016" "5151168" "5591480").PN.	USPAT	2003/11/03 16:22
-	11	5928967.URPN.	USPAT	2003/11/03 16:40
-	29	("4209349" "4358340" "4377437" "4377734" "4389482" "4419809" "4445267" "4502914" "4504574" "4552833" "4601778" "4613398" "4657845" "4690729" "4751170" "4803181" "4886565" "5599745" "5607542" "5665251" "5788447" "5792593" "5825609" "5851733" "5858621" "5863705" "5895273" "6100014" "6110637").PN.	USPAT	2003/11/03 17:59